



Fakulty of Physics Integrated Center for Applied Physics and Photonic Materials – IAPP / Institute for Applied Physics

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Date: 03 May 2024

Invitation to the ICSM 2024 International Conference

To whom it may concern,

It is a pleasure for me to invite **Minjeong Ha** to the 26. International Conference on Science and Technology of Synthetic Electronic Materials (ICSM 2024), June 23-28, 2024 in Dresden (https://icsm2024.de/).

The ICSM is the largest conference devoted to the field of organic electronics and has showcased many of the most important developments in the field over more than 40 years.

Please provide Minjeong Ha with all documents needed to deliver the important presentation at ICSM 2024. The travel dates of Minjeong Ha will be: June 16 to June 29 2024.

Sincerely

KELO

Prof. Karl Leo, Conference Chair



International Conference on Science and Technology of Synthetic Electronics Materials

23–28 June 2024 | Dresden, Germany

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